



## Material Content Data Sheet



<b>Sales Product Name</b>		IPD60R600P7		<b>Issued</b>		31. July 2018		
<b>MA#</b>		MA001976974						
<b>Package</b>		PG-TO252-3-341		<b>Weight*</b>		387.62 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.664	0.43	0.43	4294	4294
leadframe	inorganic material	phosphorus	7723-14-0	0.075	0.02		192	
	non noble metal	iron	7439-89-6	0.248	0.06		641	
	non noble metal	copper	7440-50-8	248.124	64.03	64.11	640120	640953
	non noble metal	aluminium	7429-90-5	0.420	0.11	0.11	1083	1083
wire	non noble metal	aluminium	7429-90-5	0.420	0.11	0.11	1083	1083
encapsulation	organic material	carbon black	1333-86-4	0.393	0.10		1013	
	plastics	epoxy resin	-	11.914	3.07		30736	
	inorganic material	silicondioxide	60676-86-0	118.616	30.60	33.77	306010	337759
leadfinish	non noble metal	tin	7440-31-5	3.740	0.96	0.96	9649	9649
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1313	1313
solder	non noble metal	tin	7440-31-5	0.038	0.01		99	
	noble metal	silver	7440-22-4	0.048	0.01		124	
	non noble metal	lead	7439-92-1	1.832	0.47	0.49	4726	4949
*deviation	< 10%		Sum in total:			100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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